

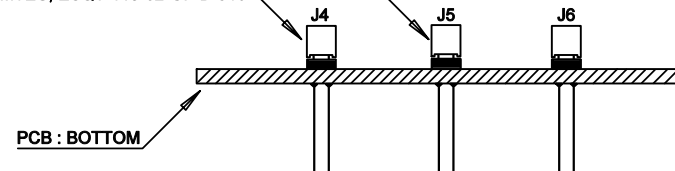
REVISION HISTORY				
ECO	REV	DESCRIPTION	APPR	DATE
-	1	PRODUCTION	ZP	12-15-15


NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY REFLOW PROFILE SHALL BE IN ACCORDANCE WITH J-STD-020 WITH MAXIMUM SOLDER TEMPERATURE OF 250 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
5. MOUNT HEADERS J4 AND J5 AND J6 AS SHOWN, DO NOT CLIP PROTRUDING LEADS.

J5, SAMTEC, ESQT-102-02-GF-S-310

J4, J6 SAMTEC, ESQT-116-02-GF-D-310



APPROVALS				1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.Linear.com LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY	
PCB DES.	NC				
APP ENG.	ZP	TITLE: TOP ASSEMBLY DRAWING: SHIELD BOARD FOR USE WITH DC2321A DUST DEMOBOARD			
		SIZE N/A	IC NO. DEMO CIRCUIT 2510A	REV. 1	
SCALE = NONE		FILENAME: DC2510A-1.PCB		SHT 1 of 2	